

N-Channel and P-Channel 12 V (D-S) MOSFET

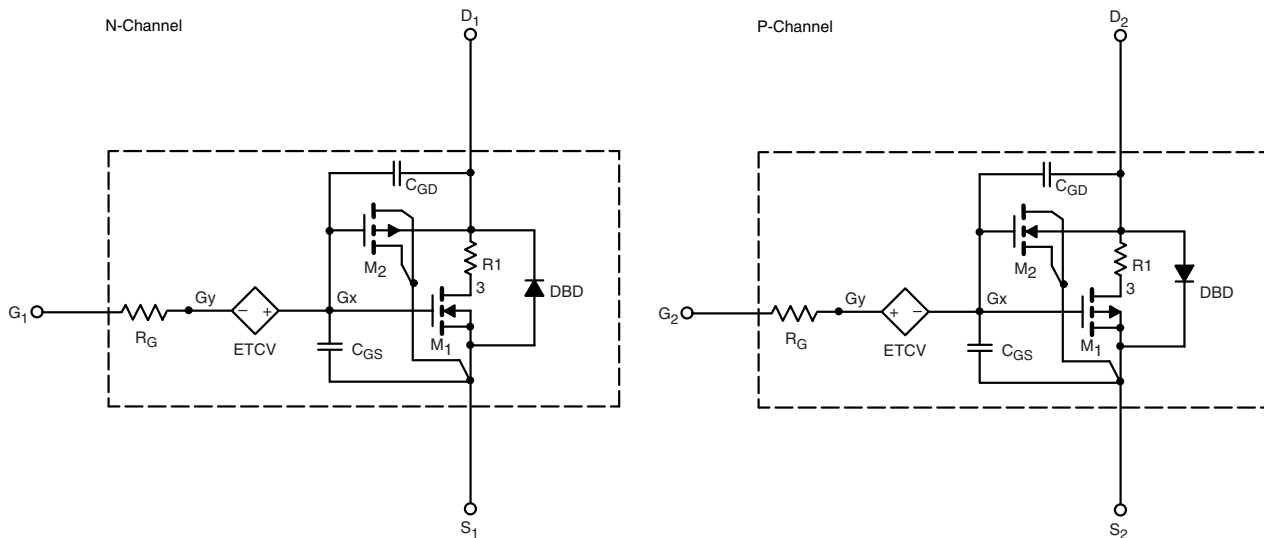
DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the n-channel and p-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to + 125 °C temperature ranges under the pulsed 0 V to 5 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

CHARACTERISTICS

- N- and P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the - 55 °C to + 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

SUBCIRCUIT MODEL SCHEMATIC



Note

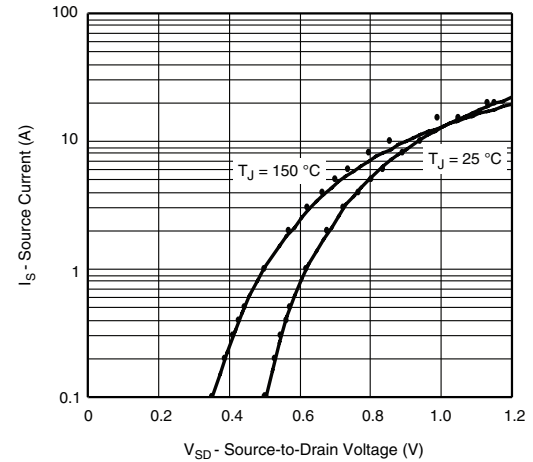
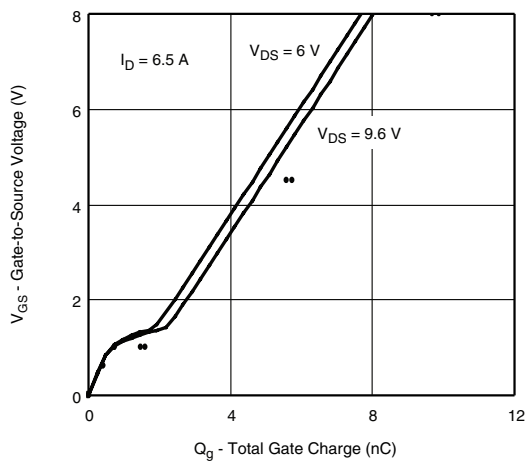
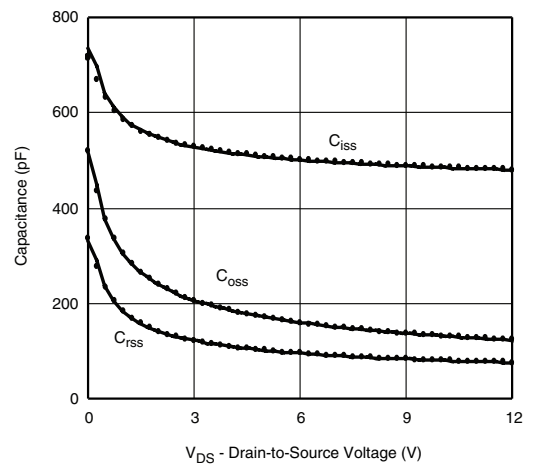
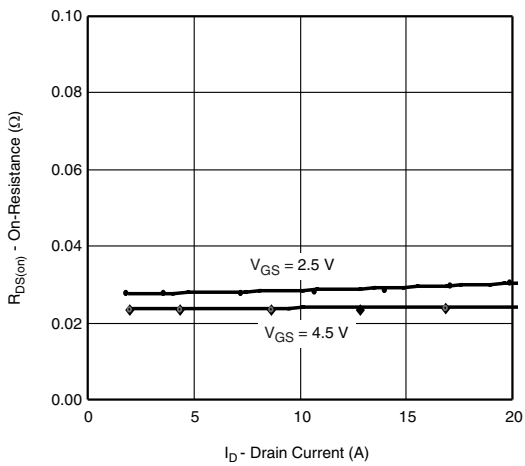
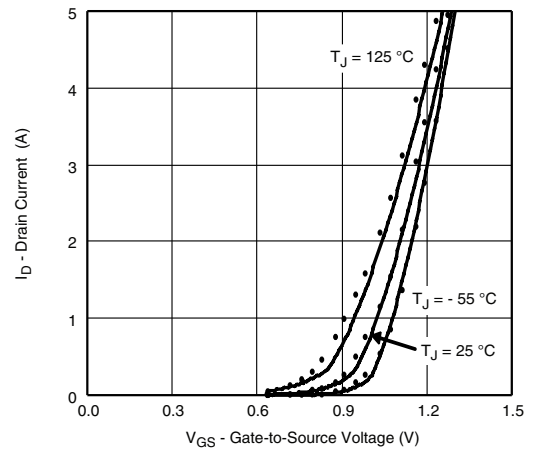
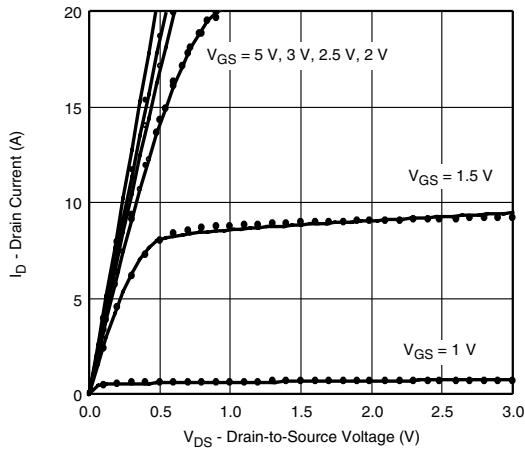
This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
PARAMETER	SYMBOL	TEST CONDITIONS		SIMULATED DATA	MEASURED DATA	UNIT
Static						
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	N-Ch	0.40	-	V
		$V_{DS} = V_{GS}, I_D = -250\ \mu\text{A}$	P-Ch	0.47	-	
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = 4.5\ \text{V}, I_D = 5\ \text{A}$	N-Ch	0.024	0.024	Ω
		$V_{GS} = -4.5\ \text{V}, I_D = -3.6\ \text{A}$	P-Ch	0.048	0.050	
		$V_{GS} = 2.5\ \text{V}, I_D = 4.6\ \text{A}$	N-Ch	0.028	0.028	
		$V_{GS} = -2.5\ \text{V}, I_D = -3.2\ \text{A}$	P-Ch	0.064	0.066	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 10\ \text{V}, I_D = 5\ \text{A}$	N-Ch	21	21	S
		$V_{DS} = -10\ \text{V}, I_D = -3.6\ \text{A}$	P-Ch	10	11	
Diode Forward Voltage ^a	V_{SD}	$I_S = 5.2\ \text{A}, V_{GS} = 0\ \text{V}$	N-Ch	0.80	0.85	V
		$I_S = -3.4\ \text{A}, V_{GS} = 0\ \text{V}$	P-Ch	0.81	-0.80	
Dynamic^b						
Input Capacitance	C_{iss}	N-Channel $V_{DS} = 6\ \text{V}, V_{GS} = 0\ \text{V},$ $f = 1\ \text{MHz}$ P-Channel $V_{DS} = -6\ \text{V}, V_{GS} = 0\ \text{V},$ $f = 1\ \text{MHz}$	N-Ch	501	500	pF
Output Capacitance	C_{oss}		P-Ch	591	590	
			N-Ch	160	160	
Reverse Transfer Capacitance	C_{rss}		P-Ch	283	280	
			N-Ch	95	100	
Total Gate Charge	Q_g		$V_{DS} = 6\ \text{V}, V_{GS} = 8\ \text{V}, I_D = 6.5\ \text{A}$	N-Ch	9.5	
		$V_{DS} = -6\ \text{V}, V_{GS} = -8\ \text{V}, I_D = -4.5\ \text{A}$	P-Ch	13.2	13.1	
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 6\ \text{V}, V_{GS} = 4.5\ \text{V}, I_D = 6.5\ \text{A}$ P-Channel $V_{DS} = -6\ \text{V}, V_{GS} = -4.5\ \text{V}, I_D = -4.3\ \text{A}$	N-Ch	4.6	5.6	
			P-Ch	7.2	8.2	
Gate-Drain Charge	Q_{gd}	N-Ch	0.72	0.72		
		P-Ch	1.2	1.2		
			N-Ch	0.74	0.74	
			P-Ch	2.8	2.8	

Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

COMPARISON OF MODEL WITH MEASURED DATA $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted
N-Channel MOSFET

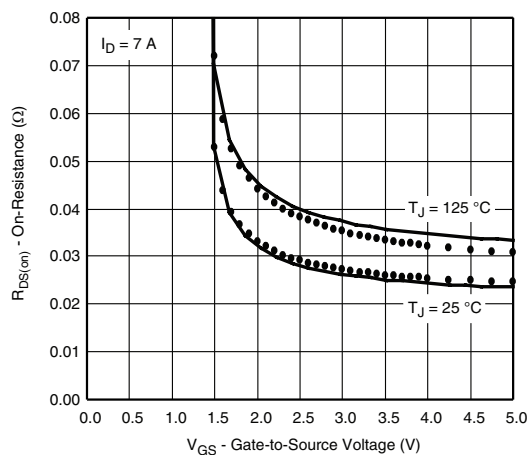
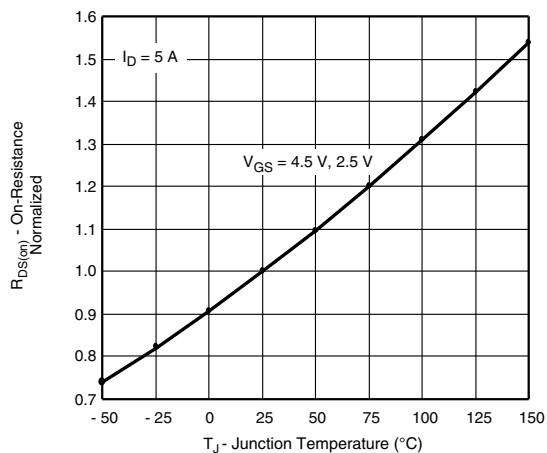


Note

Dots and squares represent measured data.

COMPARISON OF MODEL WITH MEASURED DATA $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted

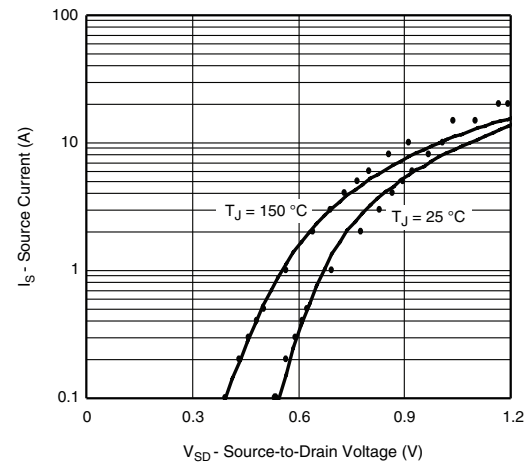
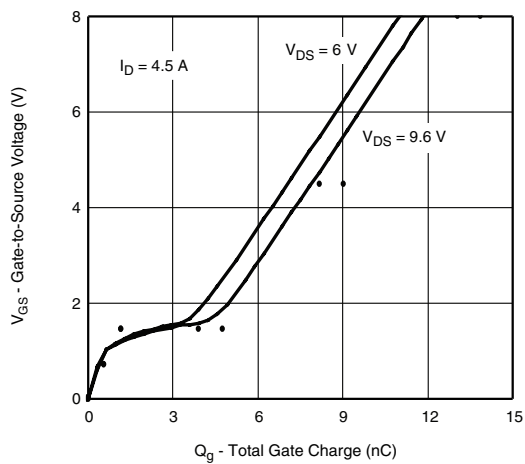
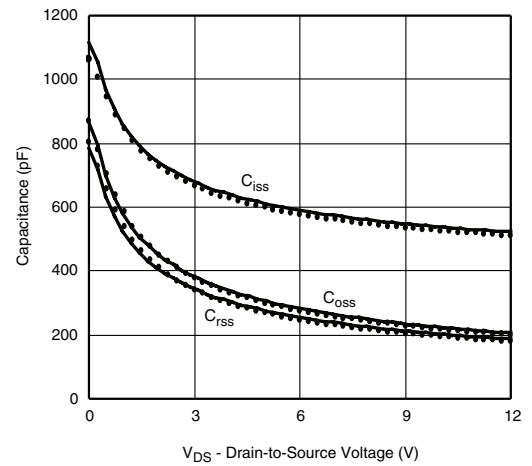
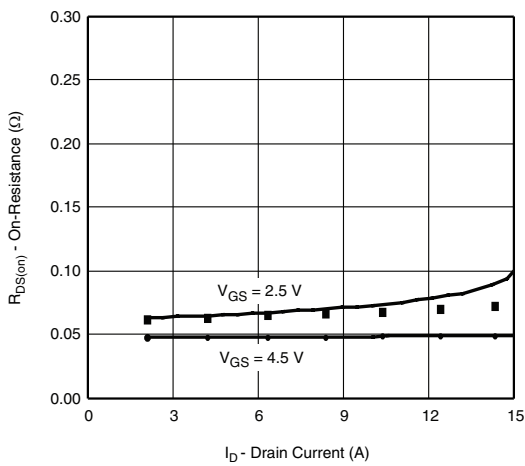
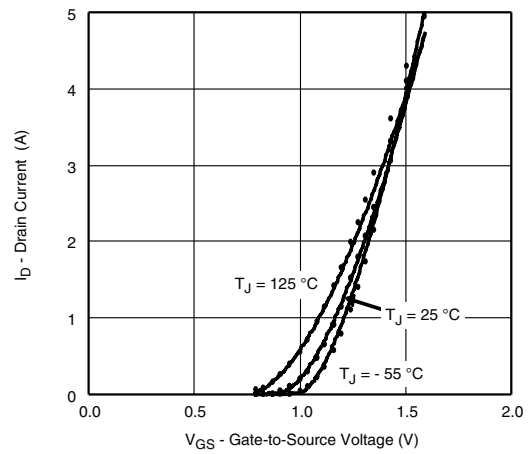
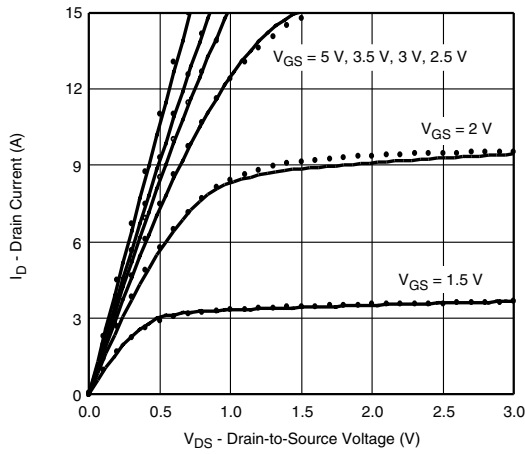
N-Channel MOSFET



Note

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P-Channel MOSFET

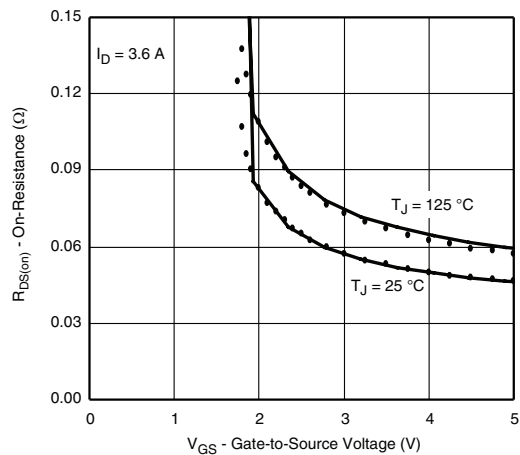
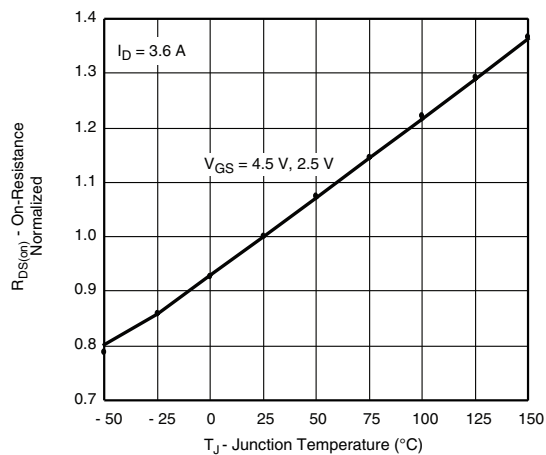


Note

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COMPARISON OF MODEL WITH MEASURED DATA $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted

P-Channel MOSFET



Note

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